



Form Type	Distribute	Version	2	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D
Supplier Information									
Company Name	TE Connectivity	Request Doc ID		Contact Name	TE Product Compliance	Contact Title			
Company Unique ID	TE Connectivity	Response Date	2020-12-01	Contact Email	productcompliance@te.com				
Contact Phone Number	+001-800-522-6752								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.									
Product									
Manufacturer Item Number	1775469-4	Amount	0.265	Version	-	Identity			
Manufacturer Item Name	HPI CONN., 2.0MM, R/A, SMT, 4P, 80U"	Weight UOM	g	Mfr Site		Authority			
Date	2020-12-01	UOM	Each						
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Sub Item	1	HPI CONN., 2.0MM, R/A, SMT, 4P, 80U"				1	0.265	g	
Material	2	Nickel Plating					0.0049	g	
Substance	3	CONTAINS NO REPORTABLE TE5081-2 SUBSTANCES		TE5081-2-1212	0.2000000000		0.0000098	g	
Substance	3	NICKEL		7440-02-0	99.8000000000		0.0048902	g	
Material	2	Tin Plating					0.0041	g	
Substance	3	TIN		7440-31-5	99.8000000000		0.0040918	g	
Substance	3	CONTAINS NO REPORTABLE TE5081-2 SUBSTANCES		TE5081-2-1212	0.2000000000		0.0000082	g	
Material	2	PIN					0.114	g	
Substance	3	IRON		7439-89-6	0.0500000000		0.000057	g	
Substance	3	COPPER		7440-50-8	64.5000000000		0.07353	g	
Substance	3	ZINC		7440-66-6	35.4500000000		0.040413	g	
Material	2	HOUSING					0.142	g	
Substance	3	BENZENE, ETHENYL-, AR-BROMO DERIVS, HOMOPOLYMERS		148993-99-1	20.0000000000		0.0284	g	
Substance	3	1,4-BENZENEDICARBOXYLIC ACID, POLYMER WITH 2-METHYL-1,8-OCTANEDIAMINE AND 1,9-NONANEDIAMINE (9CI)		169284-22-4	40.0000000000		0.0568	g	
Substance	3	FIBROUS GLASS		65997-17-3	36.0000000000		0.05112	g	
Substance	3	CONTAINS NO REPORTABLE TE5081-2 SUBSTANCES		TE5081-2-1212	4.0000000000		0.00568	g	